

X-52-854

Product Description

White spherical powder.

Product Features

- Good dispersion.
- Excellent heat resistance.
- Improves lubricity and wear resistance.

Typical Applications

- Rubber -improved abrasion resistance and heat and cold resistance. Resins - improved diffusibility of light, impact resistance, lubricity and abrasion resistance. Paints, inks and coatings - improved delustering ability, dye dispersion and lubricity.

UN Hazard Classification

No UN hazard classification.

Storage and Shelf Life

Proper storage is in the unopened original package at a cool temperature, less than 25 degrees C. Shelf life is 6 months from date of shipment.

Typical Properties

Product type (taxonomy term)	Resin Powder
TSCA Status	Listed
Particle size	0.8
Shape	Sphere
True Specific Gravity	1
hard_A	Very High
Structure	T resin
VM	1
Distribution (um)	0.2-5
INCI	Polymethylsilsesquioxane

Note: Values are not for specification purposes.

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